

Low Dark Count UV-SiPM: Development and Performance Measurements

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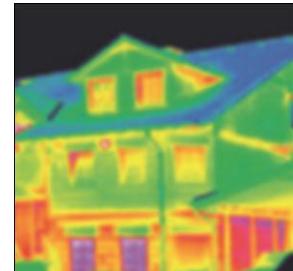
LIGHT 11

*Workshop on the Latest Developments of
Photon Detectors
Oct 31- Nov 4 2011, Ringberg Castle, Germany*





- Focused on delivering **innovative, customized optoelectronics** to OEMs seeking **high-performance, market-driven technology solutions**.
- 2010 revenues of over \$300 million
- **3,000 employees** worldwide
- **13 global manufacturing locations** in North America, Europe, and Asia
- Operates under three business groups: Lighting, Detection, Advanced Electronic Systems (AES)
- Privately held (Veritas Capital), since Nov 2010
- Formerly part of PerkinElmer





Robert John McIntyre
1928 - 1998



Robert J. McIntyre (RCA Electro Optics, Canada) presented his Theory of Microplasma Instability in Silicon in 1961, laying the basis for the development of the Geiger mode Silicon Avalanche Photodiode (G-SAPD).

R.J. McIntyre. "Theory of Microplasma Instability in Silicon", *Journal of Applied Physics*, vol. 32, no. 6, pp. 983 – 995, 1961.

R.J. McIntyre. "On the avalanche initiation probability of avalanche diodes above the breakdown voltage", *Electron Devices, IEEE Transactions on*, vol. 20 no. 7, pp. 637 – 641, 1973.

P. P. Webb, R. J. McIntyre, and J. Conradi, "Properties of avalanche photodiodes" *RCA Review* , no. 35, pp. 234-278, 1974.

TodaySPCM (Single Photon Counting Module)



Self contained, SLiK™ APD based module which detects single photons ranging from 400 –1100nm.

- Plug and play module with electronics integrated
- Includes thermoelectric cooler
- Includes quenching circuit
- Digital output

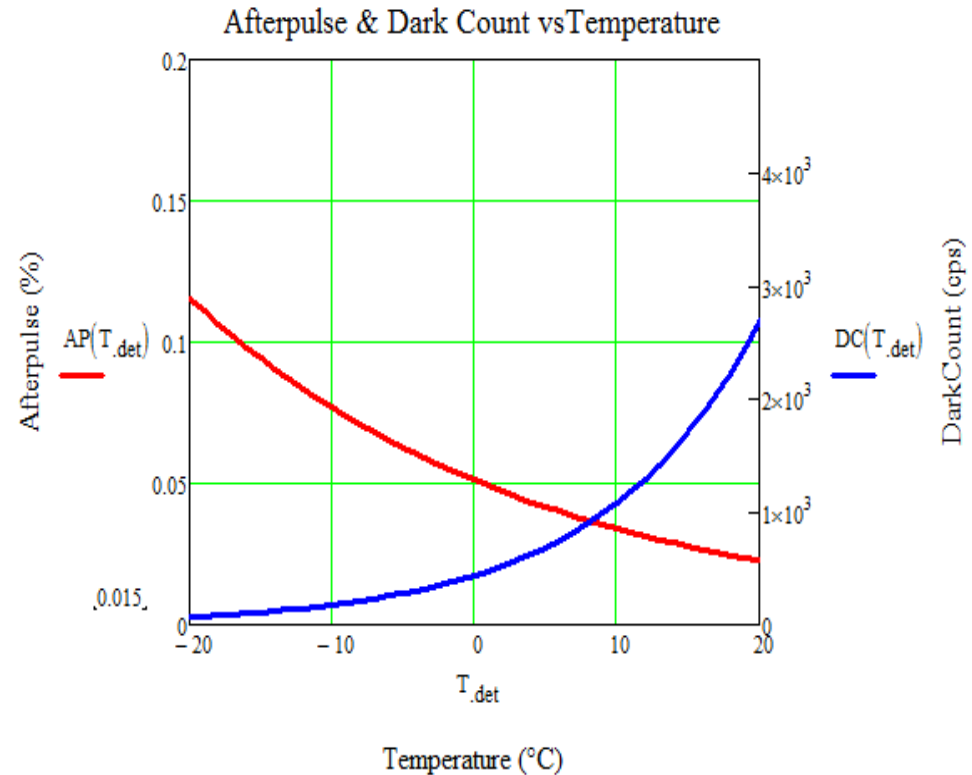
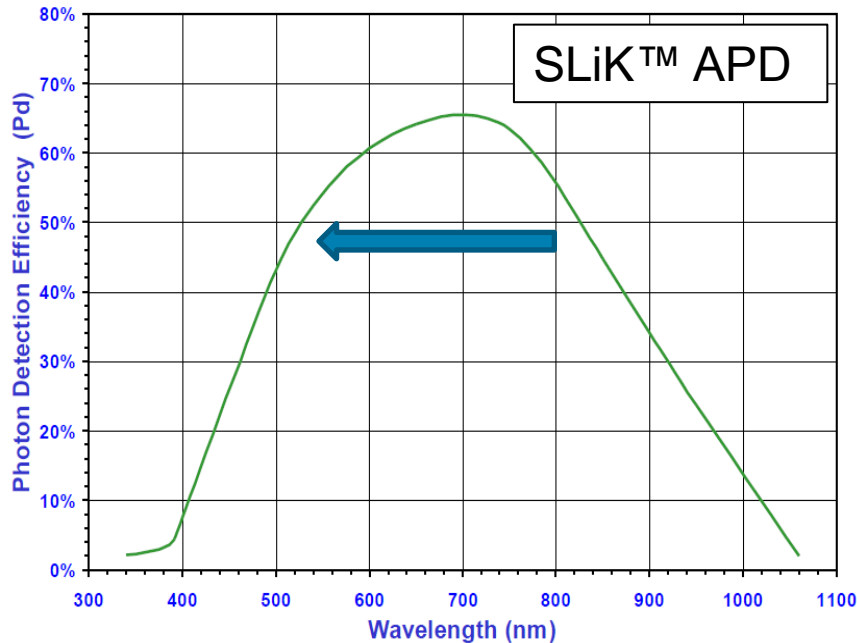


- **Large Active diameter :180 μ m**
- **Photon detection efficiency (PD) @ 700nm : 65 %**
- **Dark Count Average : 200 cps @ -10°C and 20V OV**
- **Timing resolution Typ. : < 200-350 ps**
- Maximum count rate : 30 Mcps
- Dead time : 20 ns
- After pulse probability : 0.5 %



From SPCM to SiPM

Develop an UV-enhanced SiPM

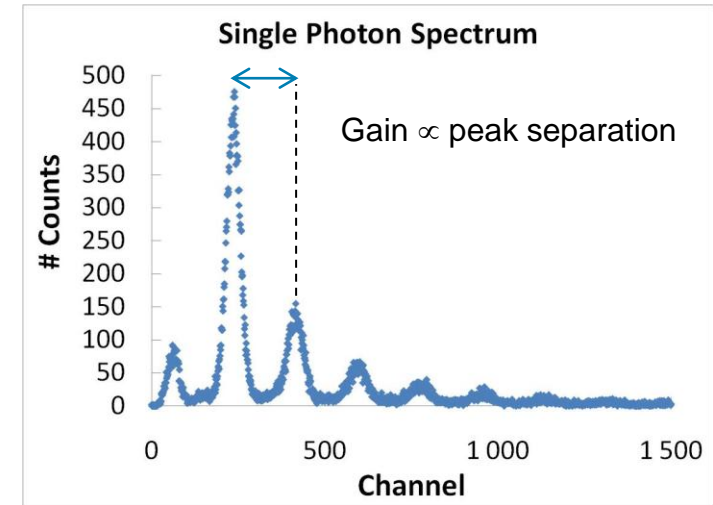
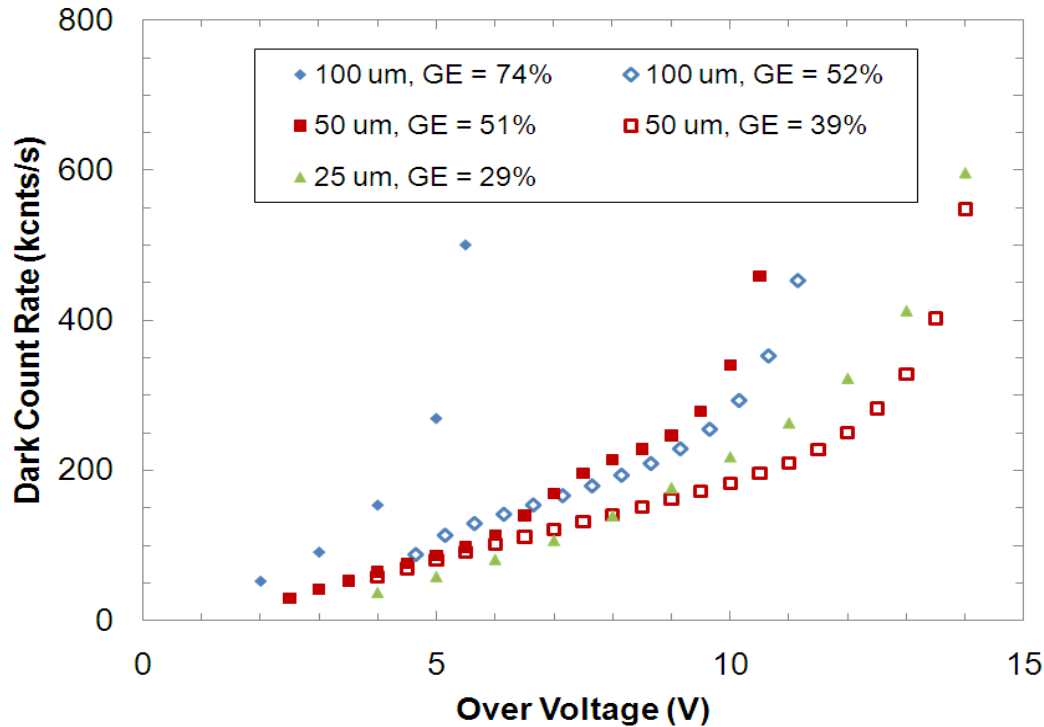


Improve photon detection efficiency around 400 nm while maintaining low dark count and tile-up an array of smaller pixels

Addressing the needs of molecular imaging and high energy physics communities



1st Generation SiPM, 2011 – highlights (1)



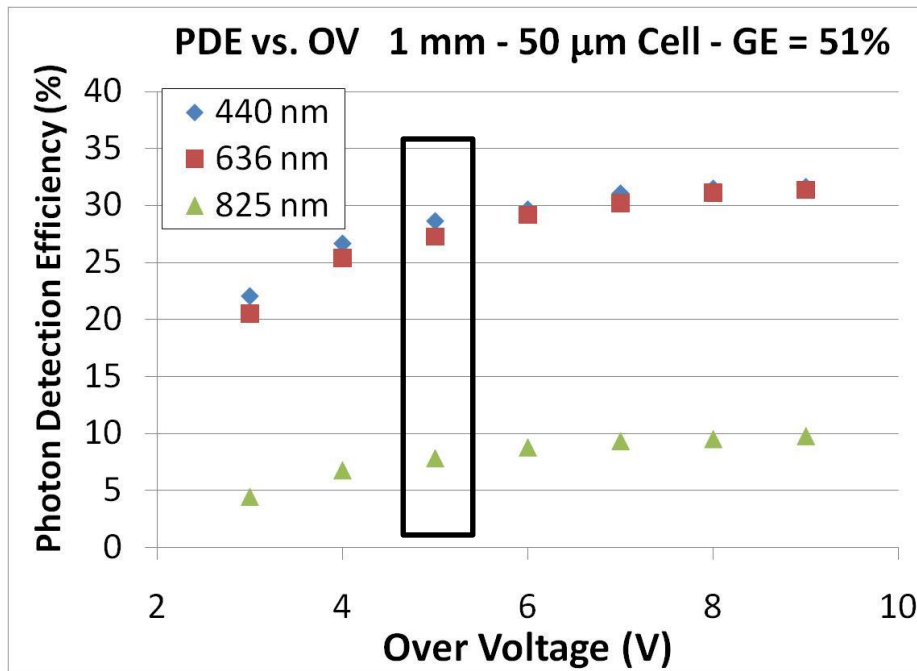
Low Dark Count (25 C)

P. Bérard et al. "Characterization study of a new UV-SiPM with low dark count rate", 2011 NDIP Conference Record, NIMA

A Barlow, J Schilz, "SiPM developments", SiPM Matching Event, CERN, 16-17 Feb 2011

1st Generation SiPM, 2011 – highlights (2)

SiPM PDE in Photon Counting Mode

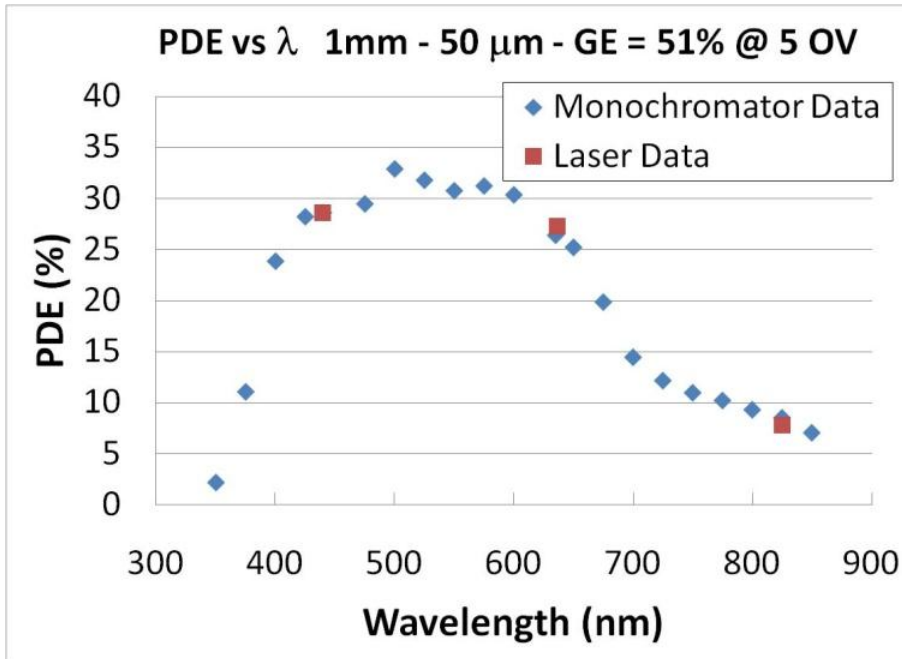


Responsivity obtained with monochromator rescaled to photon counting data points

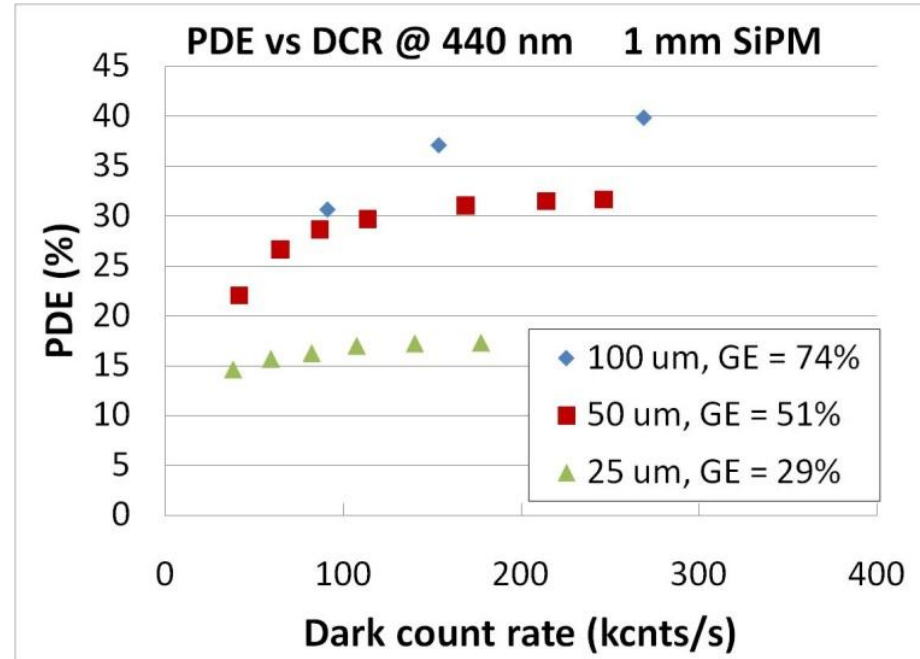
Wide spectral response

P. Eckert *et al.* Characterisation studies of silicon photomultipliers, Nucl. Instr. and Meth. A 620 (2010), pp. 217-226.

1st Generation SiPM, 2011 – highlights (3)



Broad responsivity spectrum

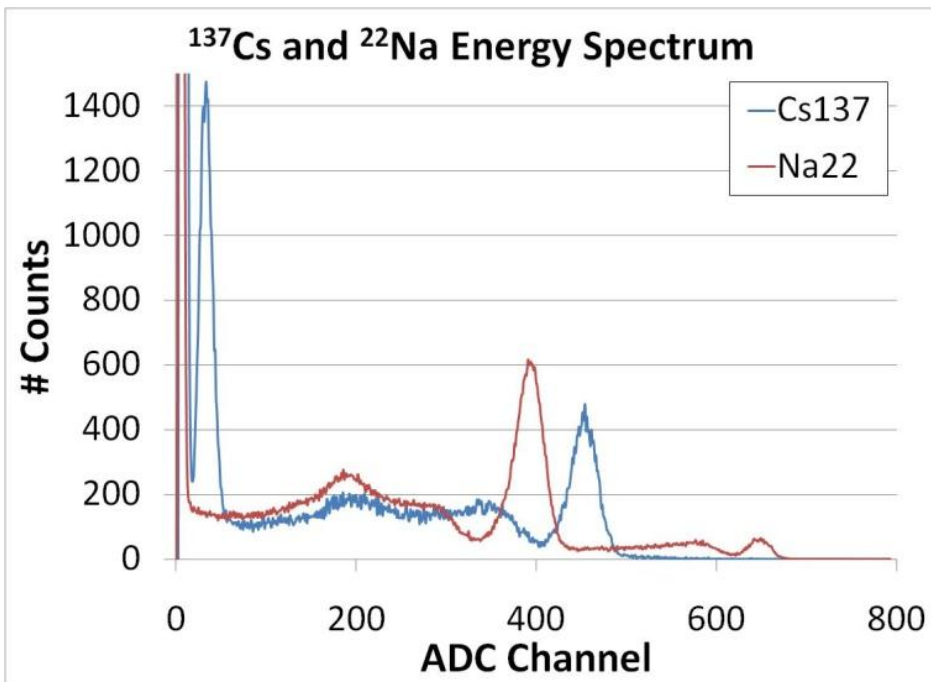


Low dark count even when PDE saturates

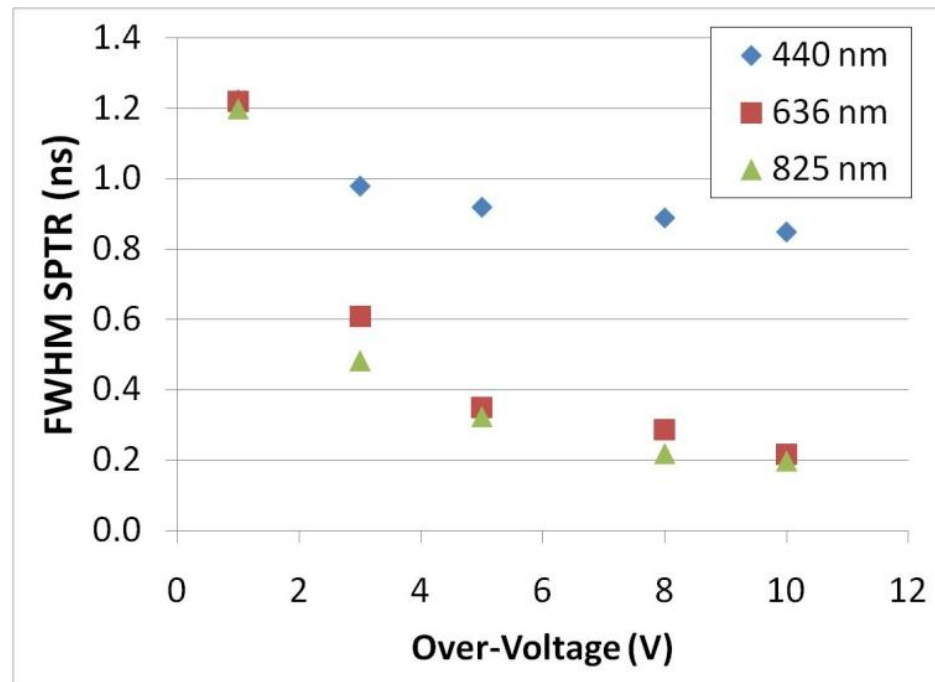
P. Bérard et al. "Characterization study of a new UV-SiPM with low dark count rate", 2011 NDIP Conference Record, NIMA

A Barlow, J Schilz, "SiPM developments", SiPM Matching Event, CERN, 16-17 Feb 2011

1st Generation SiPM, 2011 – highlights (4)



13.5 % at 511 keV



Non-optimized SPTR at 440 nm

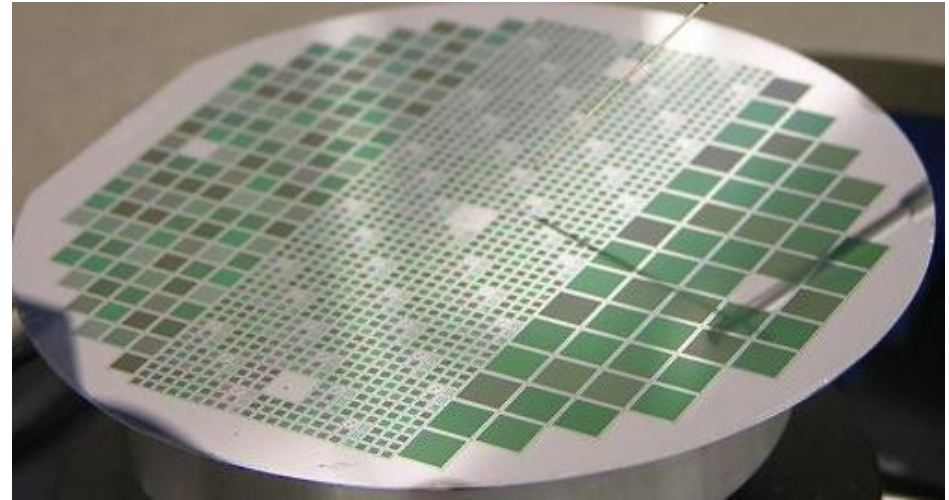
P. Bérard et al. "Characterization study of a new UV-SiPM with low dark count rate", 2011 NDIP Conference Record, NIMA.



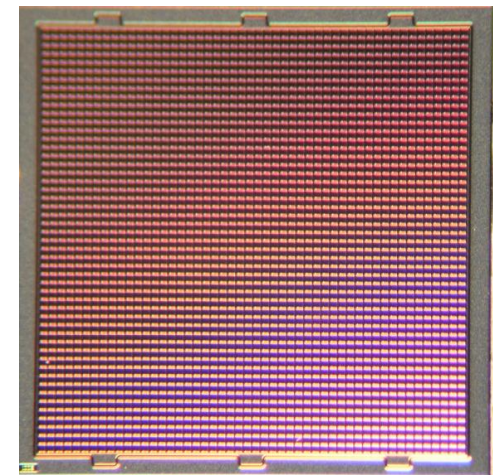
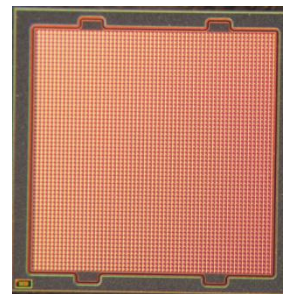
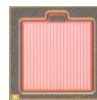
2nd Gen SiPM- towards optimization of overall SiPM performance

SiPM dimension : - 1 mm x 1 mm
- 3 mm x 3 mm
- 5 mm x 5 mm

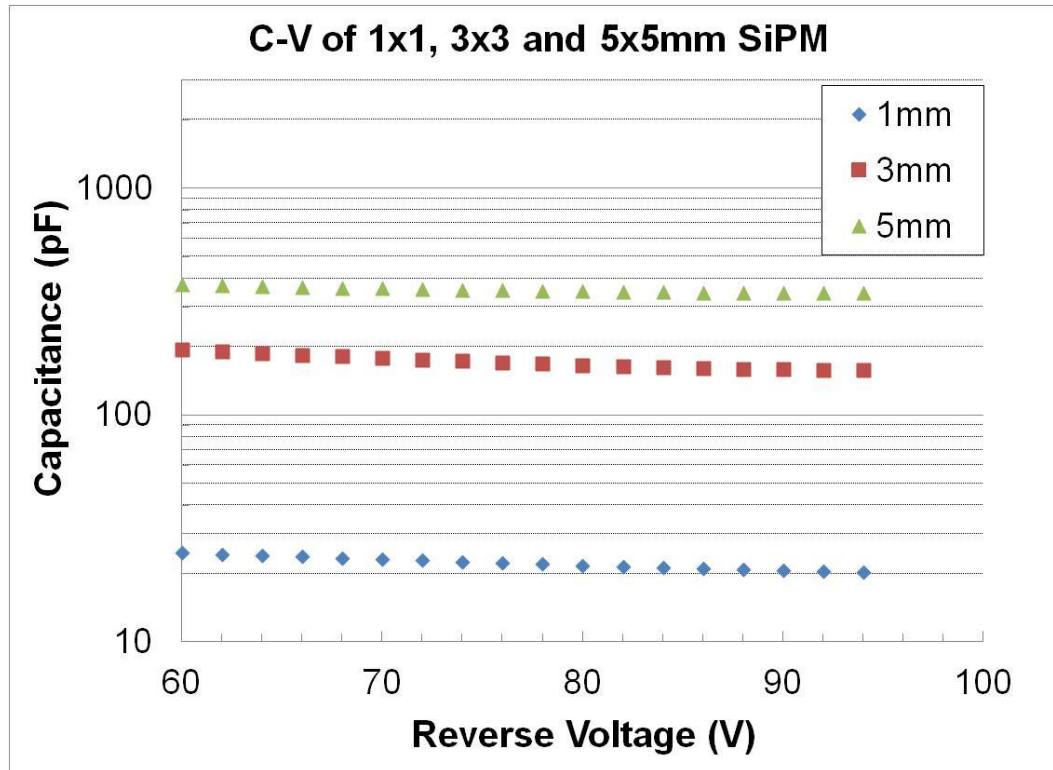
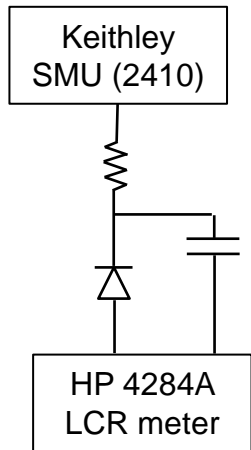
Cell dimension : - 25 μm x 25 μm
- 50 μm x 50 μm
- 100 μm x 100 μm



Geometrical efficiencies (GE) ranging from 74% to 29 % depending on pixel size



SiPM Capacitance- we trade-off some parameters



1st Generation Capacitance

- 1 x 1 mm : 12 pF
- 3 x 3 mm : 93 pF
- 5 x 5 mm : 255 pF



2nd Generation Capacitance

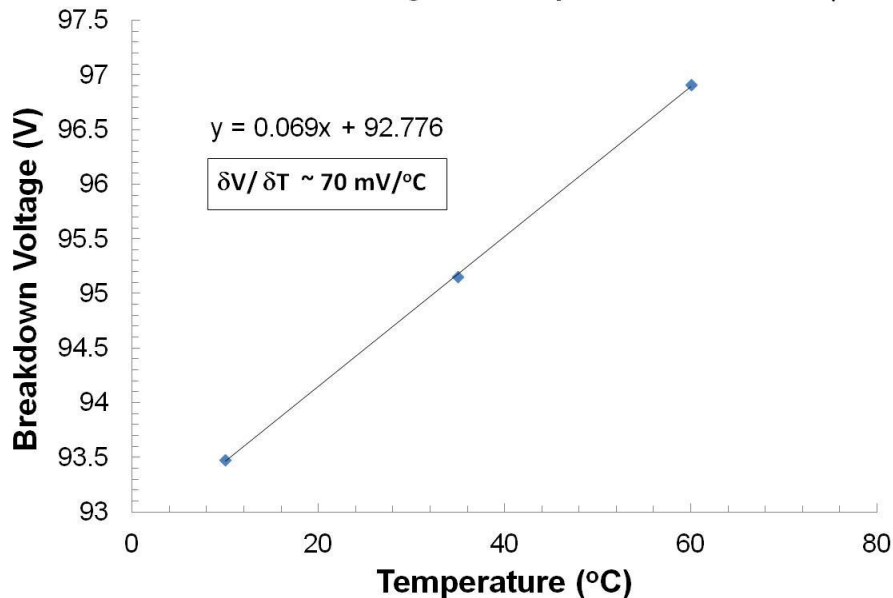
- 1 x 1 mm : 21 pF
- 3 x 3 mm : 158 pF
- 5 x 5 mm : 345 pF

<~20 pF/mm²
Low capacitance

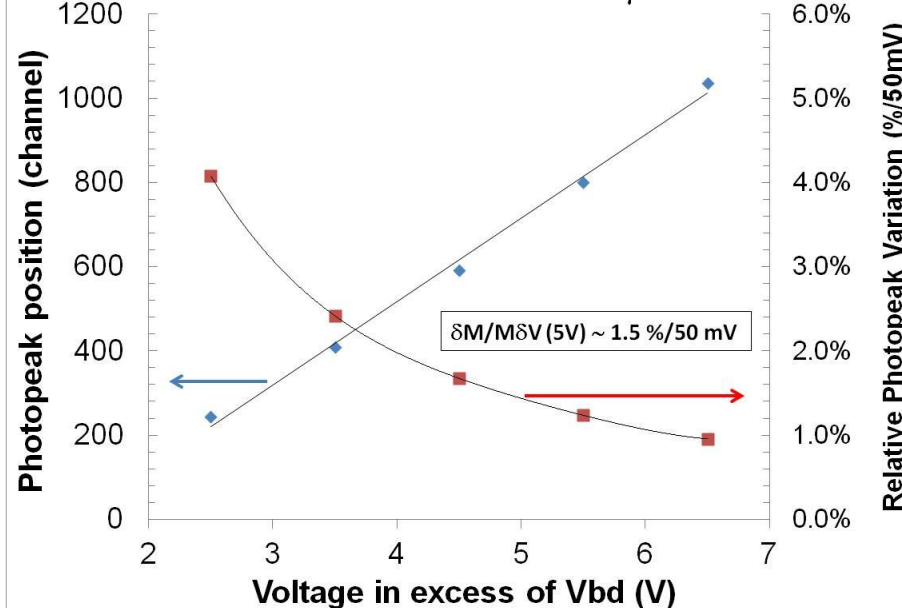
SiPM Breakdown Voltage – Gain – Temperature dependence



Breakdown Voltage vs. Temperature - 1 mm 50 μm



Gain variation - 3 mm 50 μm



1st Generation

$V_{bd} \sim 140 - 150 \text{ V}$
$\delta V / \delta T \sim 130 \text{ mV}/^\circ\text{C}$
$\frac{1}{M} \frac{\delta M}{\delta V} (5V) \sim 1\% / 50 \text{ mV}$
$\frac{1}{M} \frac{\delta M}{\delta T} (5V) \sim 2.6\% / ^\circ\text{C}$

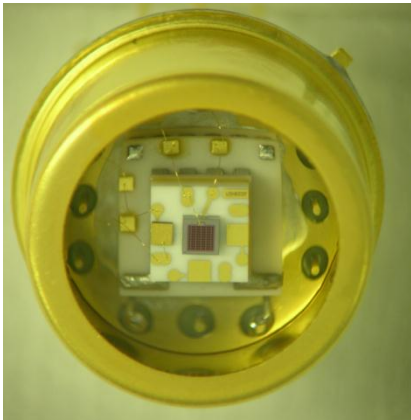
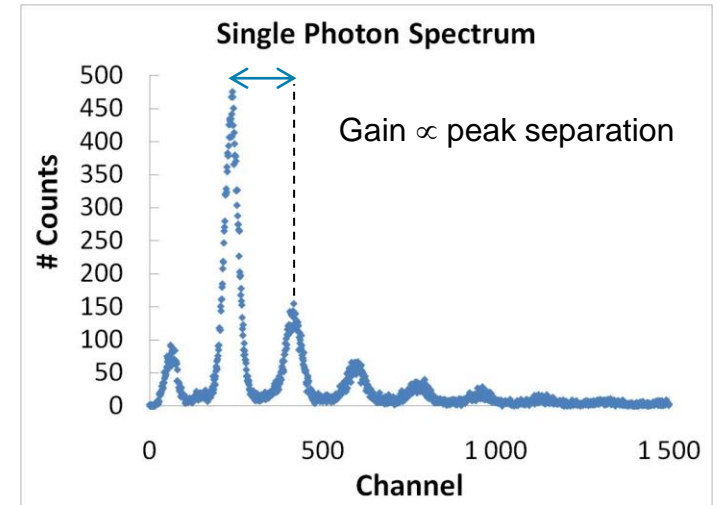
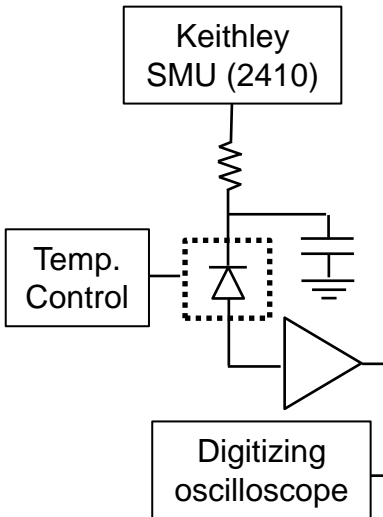


2nd Generation

$V_{bd} \sim 90 - 100 \text{ V}$
$\delta V / \delta T \sim 70 \text{ mV}/^\circ\text{C}$
$\frac{1}{M} \frac{\delta M}{\delta V} (5V) \sim 1.5\% / 50 \text{ mV}$
$\frac{1}{M} \frac{\delta M}{\delta T} (5V) \sim 2.1\% / ^\circ\text{C}$

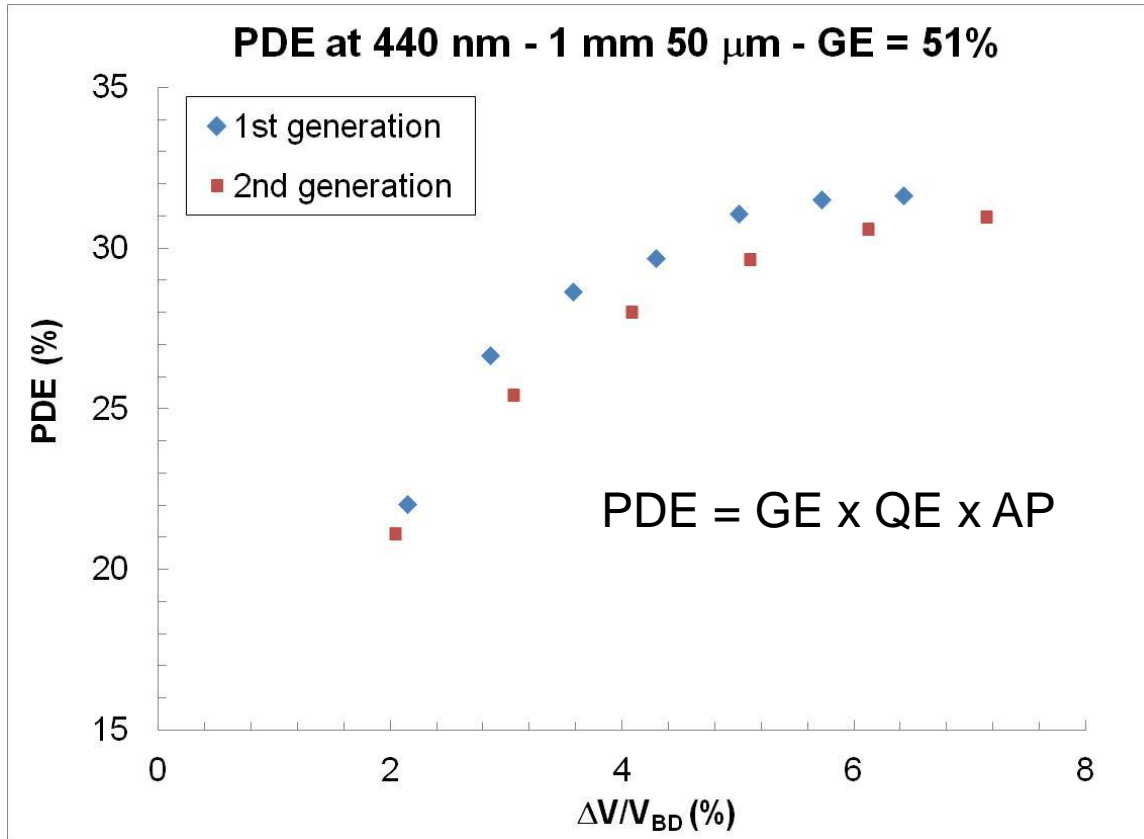
Low sensitivity to voltage and temperature eases SiPM operation

SiPM Breakdown Voltage – Gain – Temperature dependence

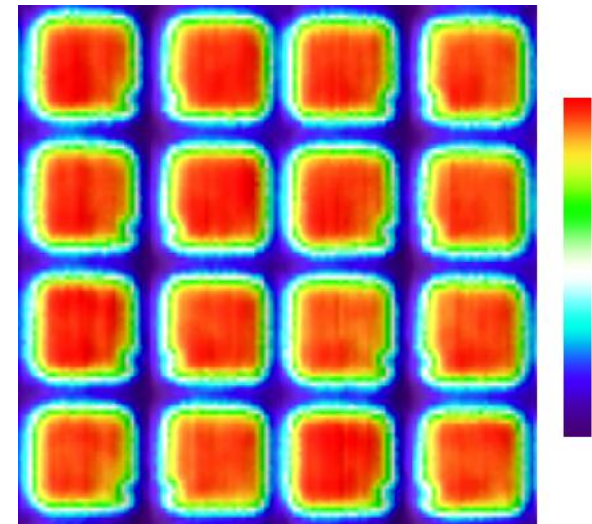




PDE Measurement obtained in photon counting mode



Zoom of 1 mm 50 μ m SiPM chip with GE = 51%



Vop ~ 6 - 8 V



Vop ~ 5 - 6 V

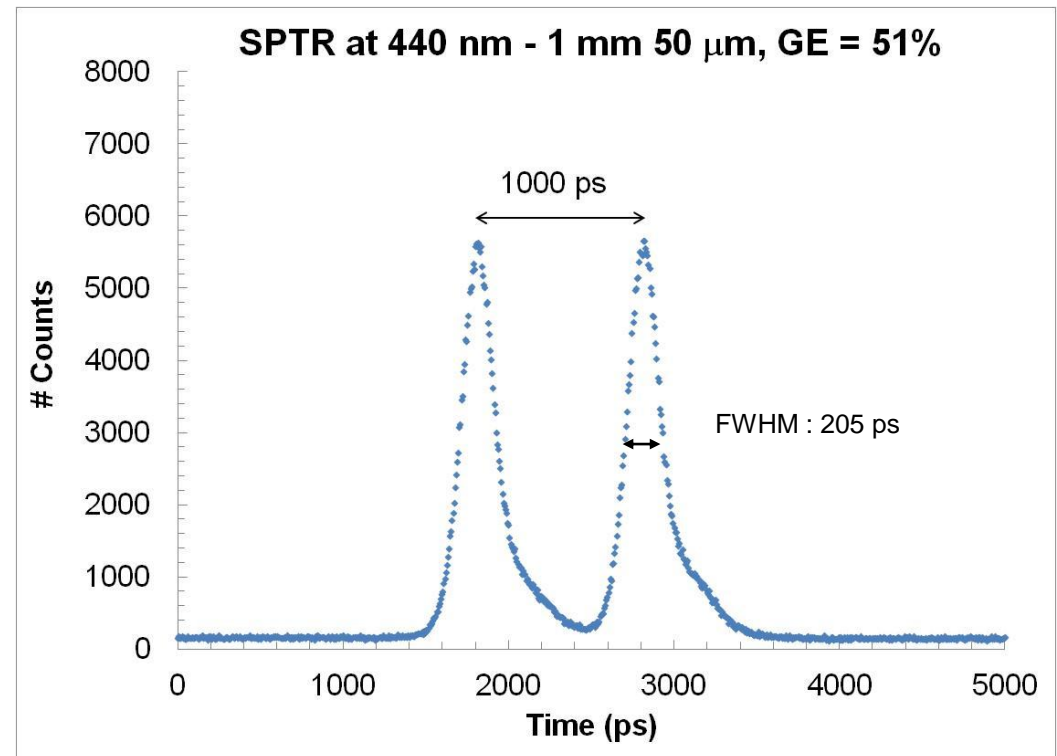
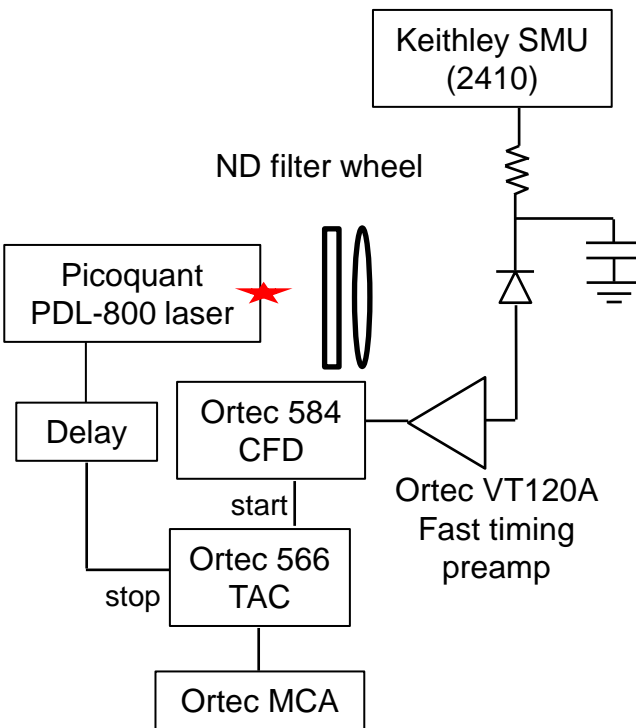
SiPM Single Photon Timing Resolution- major progress

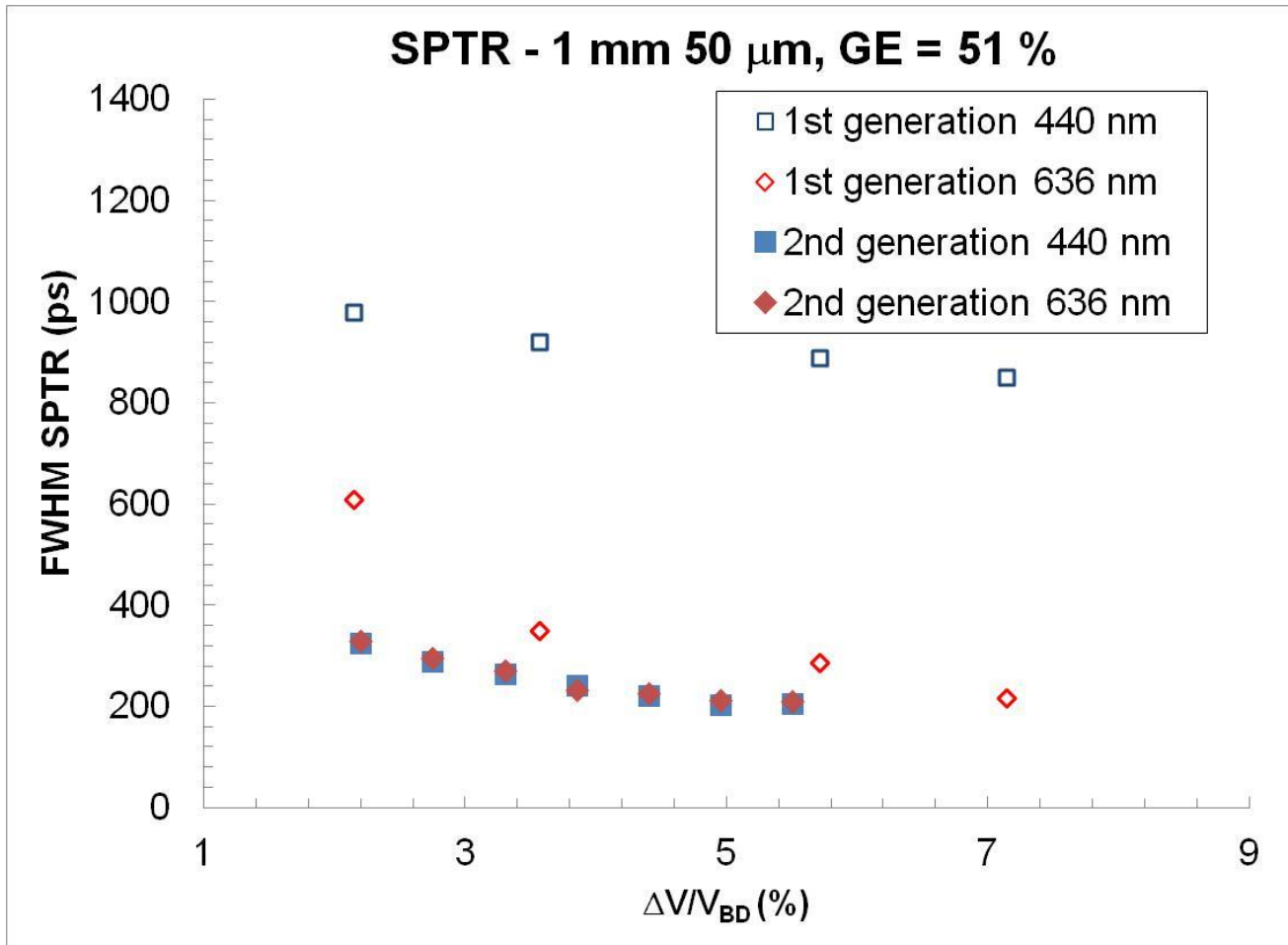


Laser output adjusted to meet single photon counting requirements

Optics to focus <20 μm light spot on one single cell.

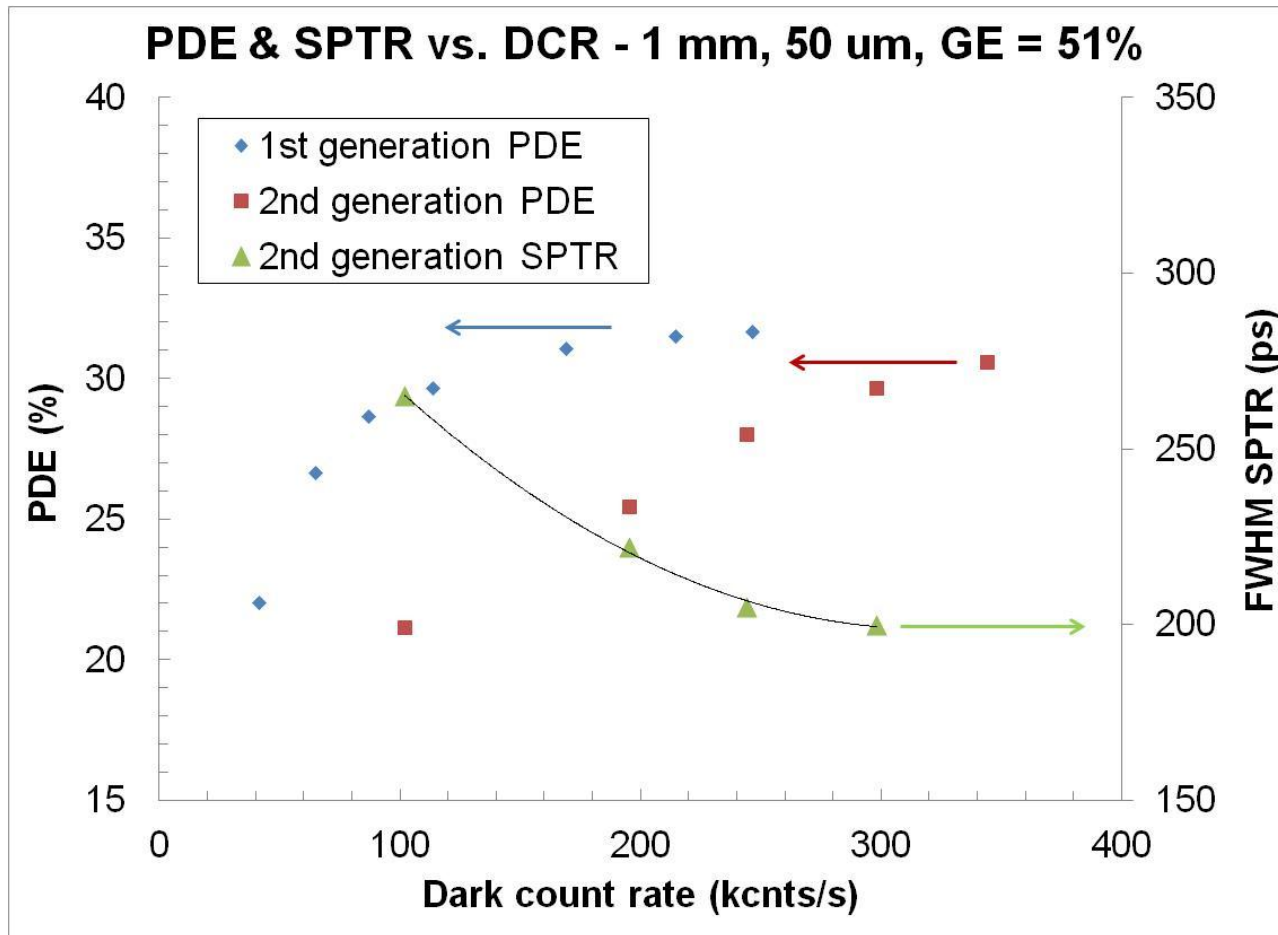
Picoquant laser head : 440 and 636 nm, jitter < 70 ps.





Main objective of reaching ~200 ps FWHM SPTR at 440 nm achieved

PDE and SPTR vs. Dark count rate

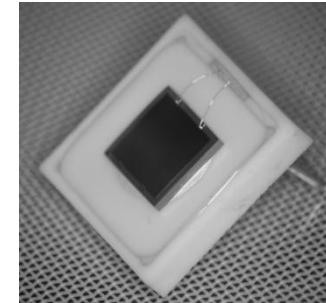
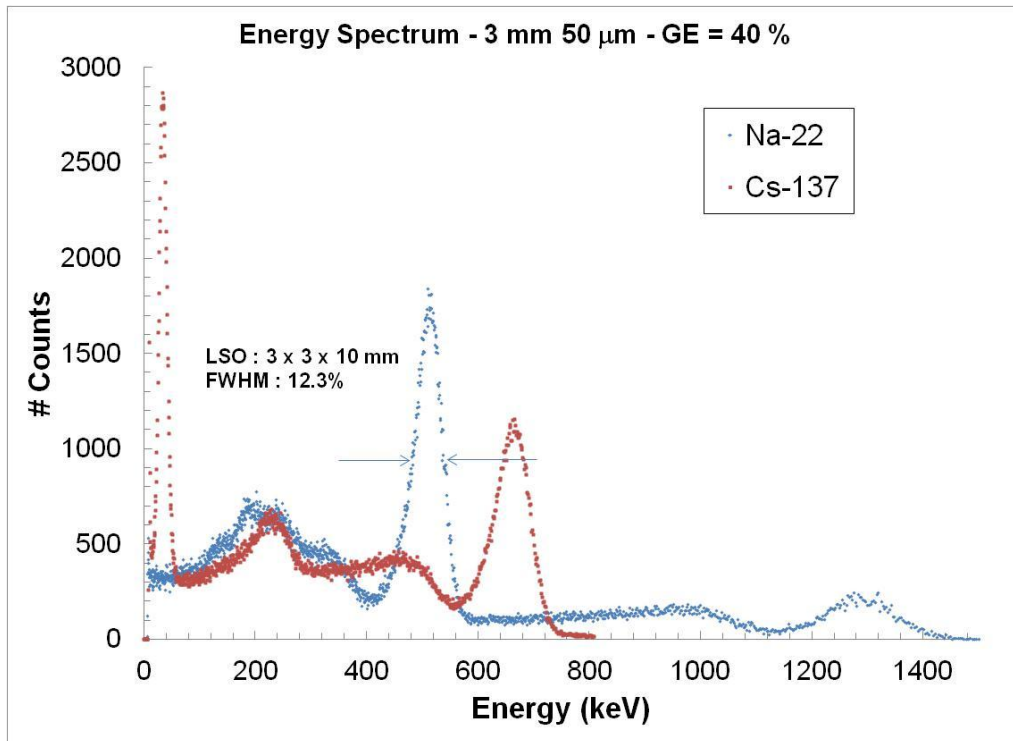


PDE and SPTR optimized at low dark count

SiPM Energy Resolution



3 x 3 mm, 50 μ m pixels, GE = 40 %



^{22}Na and ^{137}Cs : 32, 511, 662
and 1275 keV
- Correction for non-linearity

3 x 3 x 10 mm LSO
- Wrapped in Teflon
- Optically coupled with Bicon optical grease

2nd Gen SiPM- Performance Summary Table



Parameter (unless indicated otherwise, all measurements taken at V _{op} and 25°C)	Symbol				Unit
		C30742-50-1	C30742-50-3	C30742-50-5	
Active area	-	1x1	3x3	5x5	mm
# of pixels	-	400	3600	10000	-
Pixel size	-	50			μm
Geometrical Efficiency	GE	40 - 51			%
Spectral response range	λ	375-800			nm
Peak sensitivity wavelength	λ _p	475			nm
Photon detection efficiency at 440nm ¹	PDE	25 - 30			%
Operating voltage range ²	V _{op}	90-100			V
Dark count ³	DCR	200-500			kcps
Terminal Capacitance	C _t	20	175	425	pF
Timing (FWHM) at 440nm with laser	SPTR	200 - 225			ps
Gain	M	1.5x10 ⁶			-
Temperature coefficient of V _{br}	T _c = δV/δT	70			mV/°C
Gain variation with over-voltage	δM/MδV	1.2			%/50mV
Gain variation with temperature	δM/MδT	1.7			%/°C
Crosstalk ⁴	X _t	30 - 40			%
Quench resistor	R _Q	1.0-1.5			MΩ

Notes :

1) Cross-talk and afterpulse are not included in PDE.

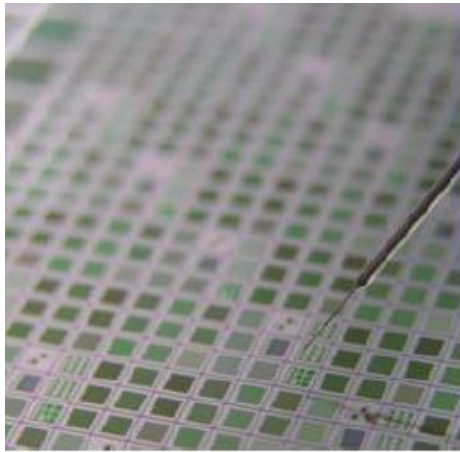
2) V_{op} = V_b + 5V.

3) DCR measured at 0.5 p.e. level.

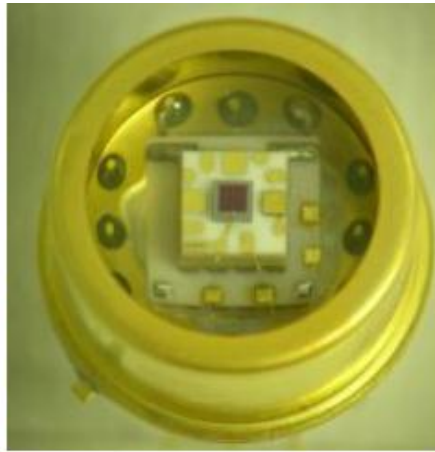
4) No cross-talk suppression implemented.



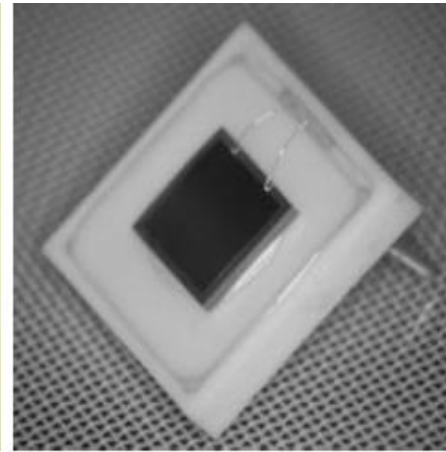
2nd Gen SiPM- Packaging Development



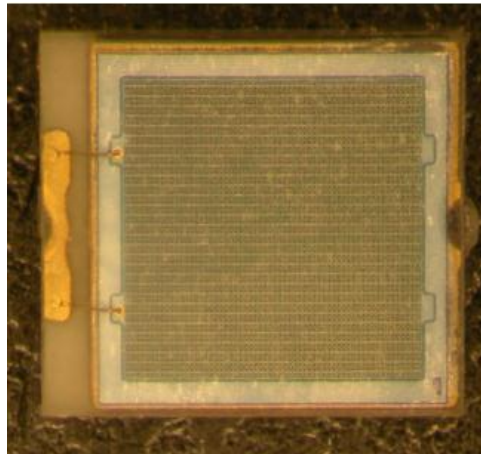
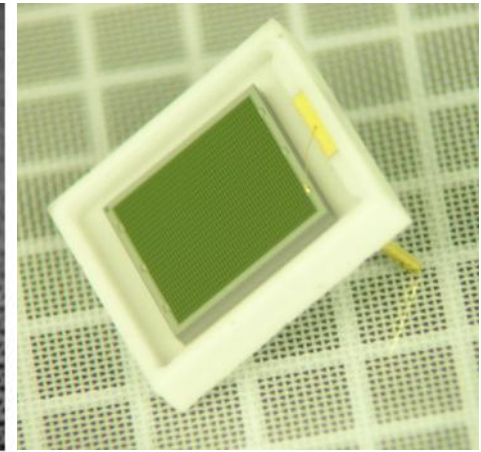
Wafer of chips



TO-can, cooler



Ceramic Header 3x3, 5x5



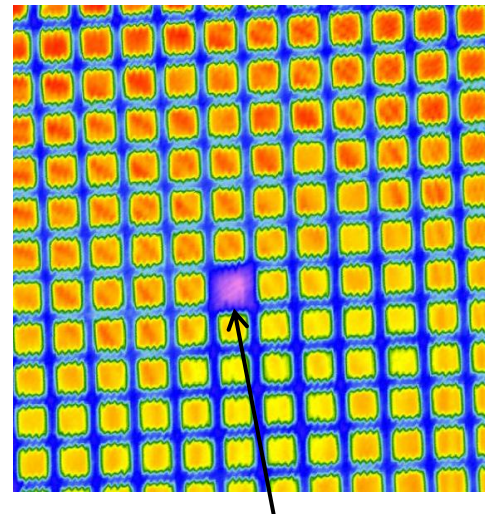
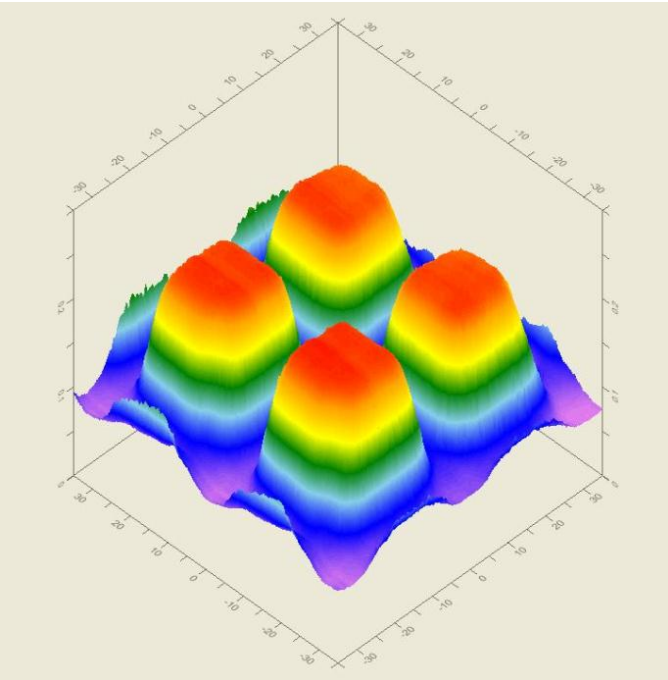
SMT package
(tile-able)

Packaging Development
progressing alongside,
1,3 and 5 mm chip sizes

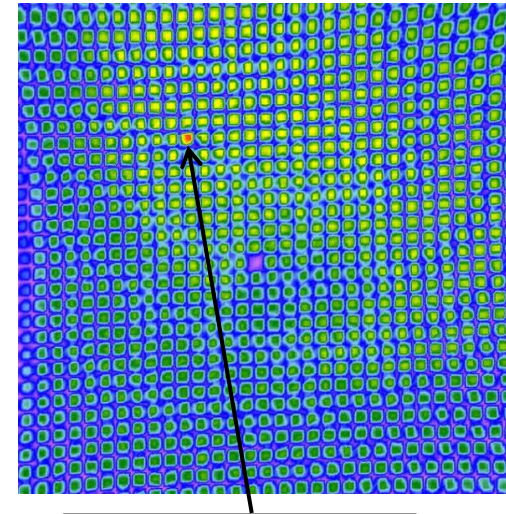
Excelitas SiPM- Towards Volume Production Capability



- 5x5mm SiPM (Optical Beam Induced Current- scanning HeNe laser, 633nm)

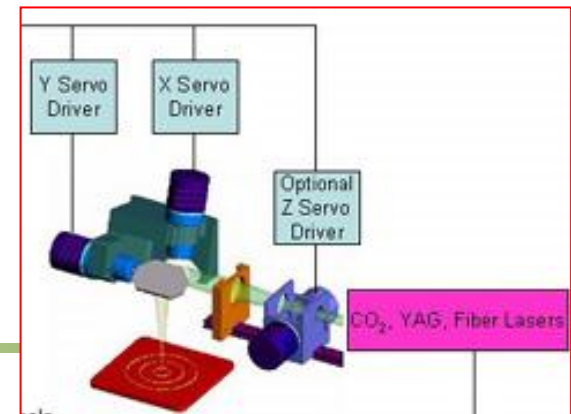


Pixel not connected easily spotted by OBIC system. Array uniformity also visible



Abnormally high gain pixel easily spotted by OBIC system.

- OBIC is a great tool to:
 - Quickly evaluate uniformity,
 - pixel layout, connectivity, etc.





Low-capacitance and low dark-count UV-sensitive SiPM has been developed

- Timing resolution issue at wavelength of interest (440 nm) improved significantly to **200 ps**
- Temperature coefficient and gain variation over temperature improved
- Planned Improvements in next months :
 - Implement cross-talk reduction
 - Improve PDE by improving QE and Geometrical Efficiency
 - Optimize design to combine both the timing resolution of second generation and the ultra-low dark count of first generation~ **100 kcounts/mm²**
- Sampling to customers now.
- Final product in early 2012.

Addressing the needs of molecular imaging and high energy physics communities



NRC Industrial Research Assistance Program



Natural Sciences and Engineering
Research Council of Canada

Conseil de recherches en sciences
naturelles et en génie du Canada

NSERC Industrial R&D Fellowship

MEPHI/MPI –Excelitas Collaboration

R. Mirzoyan, B. Dolgoshein, E. Popova et al

The logo for Excelitas Technologies features the word "EXCELITAS" in a bold, black, sans-serif font. The letter "X" is stylized with green swooshes and a dot. The word "TECHNOLOGIES" is positioned below "EXCELITAS" in a smaller, green, sans-serif font.

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